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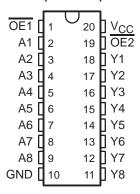
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Ceramic Flat (W) Package, and Plastic (N) and Ceramic (J) DIPs

description

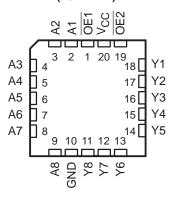
The SN54ABT541 and SN74ABT541B octal buffers and line drivers are ideal for driving bus lines or buffering memory address registers. The devices feature inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

The 3-state control gate is a two-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all eight outputs are in the high-impedance state.

SN54ABT541 . . . J OR W PACKAGE SN74ABT541B . . . DB, DW, N, OR PW PACKAGE (TOP VIEW)



SN54ABT541 . . . FK PACKAGE (TOP VIEW)



When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT541 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT541B is characterized for operation from –40°C to 85°C.

FUNCTION TABLE

	INPUTS	OUTPUT				
OE1	OE2	Α	Y			
L	L	L	L			
L	L	Н	Н			
Н	X	Χ	Z			
Х	Н	Χ	Z			

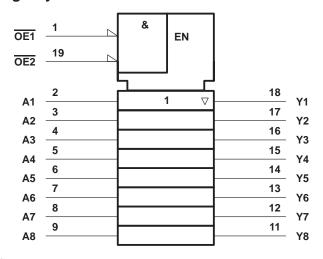


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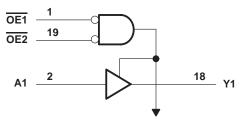
EPIC-IIB is a trademark of Texas Instruments Incorporated.



logic symbol†



logic diagram (positive logic)



To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-o	ff state, V _O –0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT541	96 mA
SN74ABT541	B 128 mA
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I _{OK} (V _O < 0)	
Package thermal impedance, θ _{JA} (see Note 2): DB package	ge 115°C/W
DW packa	ige 97°C/W
N package	e
PW packa	ge 128°C/W
Storage temperature range, T _{stq}	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 3)

		SN54ABT541		SN74AB	UNIT	
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
ЮН	High-level output current		-24		-32	mA
loL	Low-level output current		48		64	mA
TA	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

^{2.} The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Т	A = 25°C	;	SN54ABT541		SN74ABT541B		UNIT
PARAMETER	IEST CONDIT	IONS	MIN	TYP [†]	MAX	MIN	MAX	MIN	MAX	UNII
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.2		-1.2		-1.2	V
	V _{CC} = 4.5 V,	I _{OH} = -3 mA	2.5			2.5		2.5		
\/a	V _{CC} = 5 V,	$I_{OH} = -3 \text{ mA}$	3			3		3		V
VOH	V _{CC} = 4.5 V	I _{OH} = -24 mA	2			2				
	VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2		
VOL	V 45V	I _{OL} = 48 mA			0.55		0.55			V
VOL	V _{CC} = 4.5 V	$I_{OL} = 64 \text{ mA}$			0.55*				0.55	V
V _{hys}				100						mV
lį	$V_{CC} = 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±1		±1		±1	μΑ
lozpu	$V_{CC} = 0 \text{ to } 2.1 \text{ V}, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$				±50**		±50**		±50	μΑ
lozpd	$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$				±50**		±50**		±50	μΑ
lozh	V _{CC} = 5.5 V,	V _O = 2.7 V			10		10		10	μΑ
lozL	V _{CC} = 5.5 V,	V _O = 0.5 V			-10		-10		-10	μΑ
l _{off}	$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100				±100	μΑ
ICEX	$V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V}$	Outputs high			50		50		50	μΑ
10 [‡]	V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-140	-180	-50	-180	-50	-180	mA
	.,	Outputs high		5	250		250		250	μΑ
Icc	$V_{CC} = 5.5 \text{ V, I}_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$	Outputs low		22	30		30		30	mA
	11-100 01 0115	Outputs disabled		1	250		250		250	μΑ
	V _{CC} = 5.5 V, One input at 3.4 V,	Outputs enabled			1.5		1.5		1.5	mA
∆I _{CC} §		Outputs disabled			50		50		50	μΑ
	Other inputs at V _{CC} or GND	Control inputs			1.5		1.5		1.5	mA
C _i	$V_1 = 2.5 \text{ V or } 0.5 \text{ V}$			3						pF
Co	V _O = 2.5 V or 0.5 V			6						pF

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

	FROM (INPUT)							
PARAMETER		TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
t _{PLH}	А		1	2.6	4.1	1	4.6	ns
^t PHL		ı	1	2.9	4.2	1	4.7	115
^t PZH	ŌĒ		1.1	3.1	4.8	1.1	5.4	ns
t _{PZL}		ı	2.1	4.4	5.9	2.1	7	115
^t PHZ	ŌĒ	_	2.1	5.1	6.6	2.1	7.5	ns
t _{PLZ}		1	1.7	4.7	6.2	1.7	6.7	115



 $^{^{\}star\star}$ On products compliant to MIL-PRF-38535, this parameter is not production tested.

[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[§] This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

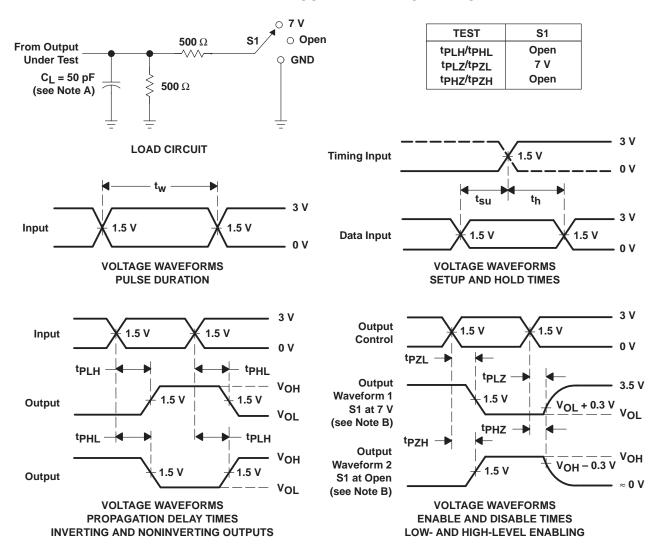
SN54ABT541, SN74ABT541B **OCTAL BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS SCBS093K – JANUARY 1991 – REVISED OCTOBER 1998

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

				SN7	4ABT54	1B		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V 4 = 25°C	', ;	MIN	MAX	UNIT
			MIN	TYP	MAX			
t _{PLH}	A	Y	1	2	3.2	1	3.6	ns
^t PHL			1	2.6	3.5	1	3.9	115
^t PZH	ŌĒ	V	2	3.5	4.5	2	4	ns
tPZL		, <u> </u>	1.9	4	5.1	1.9	5.9	115
^t PHZ	ŌĒ	Y	2.2	4.4	5.4	2.2	5.8	20
t _{PLZ}			1.5	3	4	1.5	4.4	ns
t _{sk(o)} †					0.5		0.5	ns

[†] Skew between any two outputs of the same package switching in the same direction

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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